

PCN # 1597

DATE: October 14, 2016



EXPECTED PCN SHIP DATE: October 14, 2016

Quality Assurance
160 Rio Robles
San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE
 PRODUCT CHANGE NOTICE

MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE
THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN WAFER FAB ASSEMBLY TEST ELEC/MECH SPECS

AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: Devices with WLP processing in Maxim's Dallas Texas Bump Fab

CHANGE TO: Devices to be processed for WLP at: ASEK (Advanced Semiconductor Engineering Group, Kaohsiung Taiwan)

JUSTIFICATION: Maxim is closing its Dallas Texas bump fab facility. The last production lots are planned for completion by the end of October CY2016. The facility is planned to close no later than the end of January CY2017. All single sourced devices processed in Dallas will be moved to ASE.

There are no changes to the form, fit, or function of the devices.
Please see the attached reliability report, R28250FQ.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

Nasser Ali Chaouche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Maxim Integrated Company Representative or Nasser AliChaouche, PCN Coordinator
408-601-5660 / pcn.coordinator@maximintegrated.com